

1. General description

Planar passivated Silicon Controlled Rectifier (SCR) in a SOT186A (TO-220F) plastic package intended for use in applications requiring high bidirectional blocking voltage capability, high current inrush capability and high thermal cycling performance.

2. Features and benefits

- AC power control
- High bidirectional blocking voltage capability
- High thermal cycling performance
- Planar passivated for voltage ruggedness and reliability
- Package meets UL1557 isolation test requirement rated at 2500V RMS
- Package meets UL94V0 flammability requirement
- Package is RoHS compliant
- Very high immunity to false turn-on by dv/dt and IEC 61000-4-4 fast transient

3. Applications

- Capacitive Discharge Ignition (CDI)
- Crowbar protection
- Inrush protection
- Motor control
- Voltage regulation

4. Quick reference data

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
V _{RRM}	repetitive peak reverse voltage		-	-	800	V
I _{T(AV)}	average on-state current	half sine wave	-	-	16	A
I _{T(RMS)}	RMS on-state current	half sine wave; T _h ≤ 30 °C; <u>Fig. 1;</u> <u>Fig. 2; Fig. 3</u>	-	-	25	A
I _{TSM}	non-repetitive peak on- state current	half sine wave; T _{j(init)} = 25 °C; t _p = 10 ms; <u>Fig. 4</u> ; <u>Fig. 5</u>	-	-	300	A
		half sine wave; T _{j(init)} = 25 °C; t _p = 8.3 ms	-	-	330	A
T _i	junction temperature		-	-	125	°C

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Symbol	Parameter	Conditions	Min	Тур	Max	Unit
I _{GT}	gate trigger current	V_D = 12 V; I _T = 0.1 A; T _j = 25 °C; <u>Fig. 7</u>	-	-	35	mA
Dynamic chara	acteristics					
dV _D /dt	rate of rise of off-state voltage	V_{DM} = 536 V; T _j = 125 °C; exponential waveform; gate open circuit	200	-	-	V/µs

5. Pinning information

Pin	Symbol	Description	Simplified outline	Graphic symbol
1	К	cathode	mb	А-Ӈ+К
2	А	anode		G sym037
3	G	gate		Symusi
mb	n.c.	mounting base; isolated		
			TO-220F (SOT186A)	

6. Ordering information

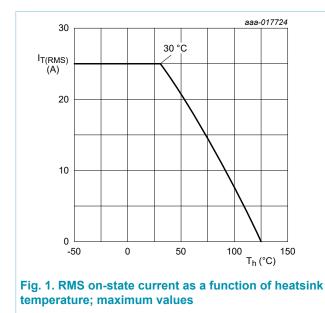
Table 3. Ordering information							
Type number	Package						
	Name	Description	Version				
BT145X-800R	TO-220F	plastic single-ended package; isolated heatsink mounted; 1 mounting hole; 3-lead TO-220 "full pack"	SOT186A				

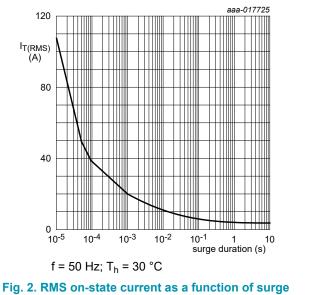
7. Limiting values

Table 4. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions	Min	Max	Unit
V _{DRM}	repetitive peak off-state voltage		-	800	V
V _{RRM}	repetitive peak reverse voltage		-	800	V
I _{T(AV)}	average on-state current	half sine wave	-	16	А
I _{T(RMS)}	RMS on-state current	half sine wave; $T_h \le 30$ °C; <u>Fig. 1</u> ; <u>Fig. 2</u> ; <u>Fig. 3</u>	-	25	A
I _{TSM}	non-repetitive peak on- state current	half sine wave; $T_{j(init)}$ = 25 °C; t_p = 10 ms; Fig. 4; Fig. 5	-	300	A
		half sine wave; $T_{j(init)}$ = 25 °C; t_p = 8.3 ms	-	330	А
l ² t	I ² t for fusing	t _p = 10 ms; SIN	-	450	A²s
dl _T /dt	rate of rise of on-state current	I _G = 70 mA	-	200	A/µs
I _{GM}	peak gate current		-	5	А
V _{RGM}	peak reverse gate voltage		-	5	V
P _{GM}	peak gate power		-	20	W
P _{G(AV)}	average gate power	over any 20 ms period	-	0.5	W
T _{stg}	storage temperature		-40	150	°C
Tj	junction temperature		-	125	°C

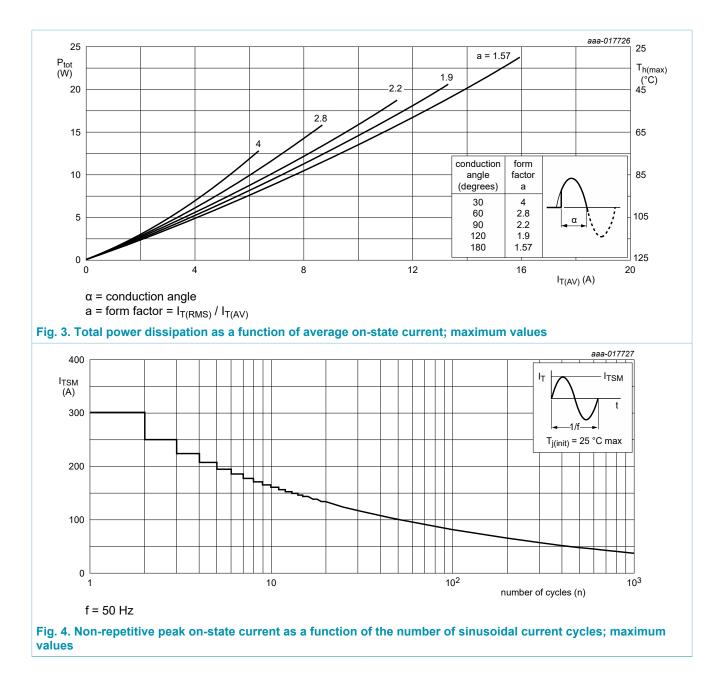




duration; maximum values

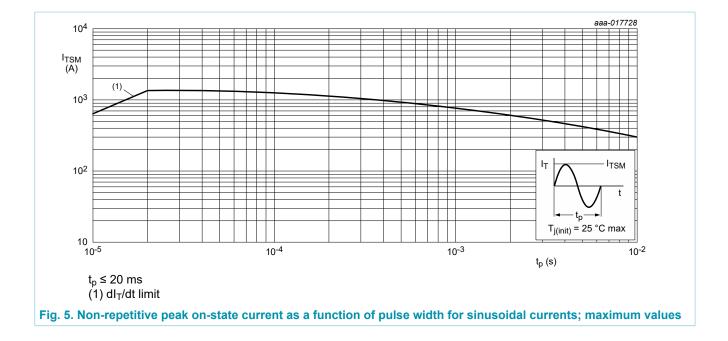
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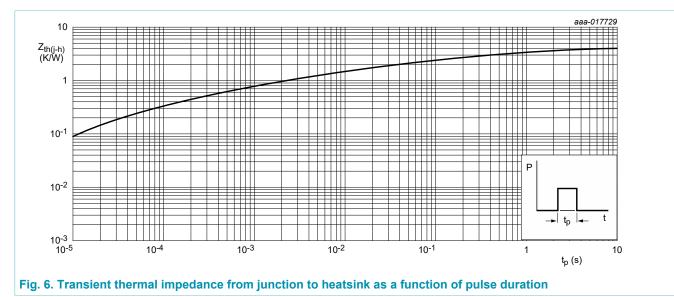
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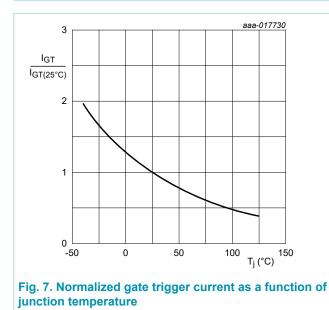
8. Thermal characteristics

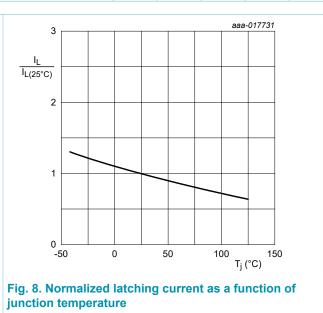
Symbol	Parameter	Conditions	Mi	ו Тур	Max	Unit
R _{th(j-h)}	thermal resistance from junction to heatsink	full cycle or half cycle; with heatsink compound; Fig. 6	-	-	4	K/W
		full cycle or half cycle; without heatsink compound	-	-	5.5	K/W
R _{th(j-a)}	thermal resistance from junction to ambient free air	in free air	-	55	-	K/W



9. Characteristics

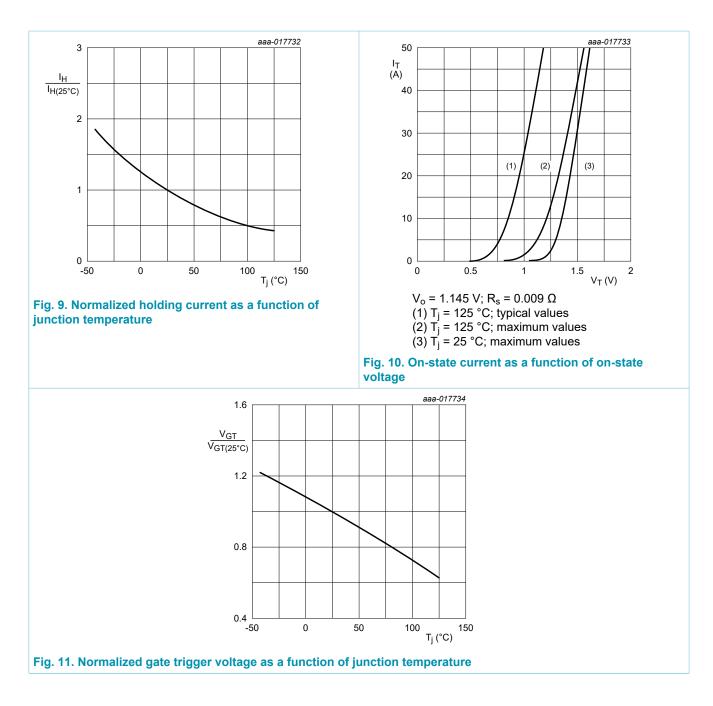
Symbol	Parameter	Conditions		Min	Тур	Max	Unit
Static chara	acteristics	·					
I _{GT}	gate trigger current	V _D = 12 V; I _T = 0.1 A; T _j = 25 °C; <u>Fig. 7</u>		-	-	35	mA
۱ _L	latching current	V_D = 12 V; I _G = 0.1 A; T _j = 25 °C; <u>Fig. 8</u>		-	-	80	mA
I _H	holding current	V _D = 12 V; T _j = 25 °C; <u>Fig. 9</u>		-	-	60	mA
V _T	on-state voltage	I _T = 30 A; T _j = 25 °C; <u>Fig. 10</u>		-	1.1	1.5	V
V _{GT}	gate trigger voltage	V _D = 12 V; I _T = 0.1 A; T _j = 25 °C; <u>Fig. 11</u>		-	0.6	1	V
		V _D = 800 V; I _T = 0.1 A; T _j = 125 °C; <u>Fig. 11</u>		0.25	0.4	-	V
I _D	off-state current	V _D = 800 V; T _j = 125 °C		-	0.2	1	mA
I _R	reverse current	V _R = 800 V; T _j = 125 °C		-	0.2	1	mA
Dynamic ch	naracteristics		·				
dV _D /dt	rate of rise of off-state voltage	V_{DM} = 536 V; T _j = 125 °C; exponential waveform; gate open circuit		200	-	-	V/µs
t _{gt}	gate-controlled turn-on time	I_{TM} = 40 A; V _D = 800 V; I _G = 0.1 mA; dI _G /dt = 5 A/µs; T _j = 25 °C		-	2	-	μs
t _q	commutated turn-off time	V_{DM} = 536 V; T _j = 125 °C; I _{TM} = 50 A; V_R = 25 V; (dI _T /dt) _M = 30 A/µs; dV _D / dt = 50 V/µs		-	70	-	μs





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10. Package outline

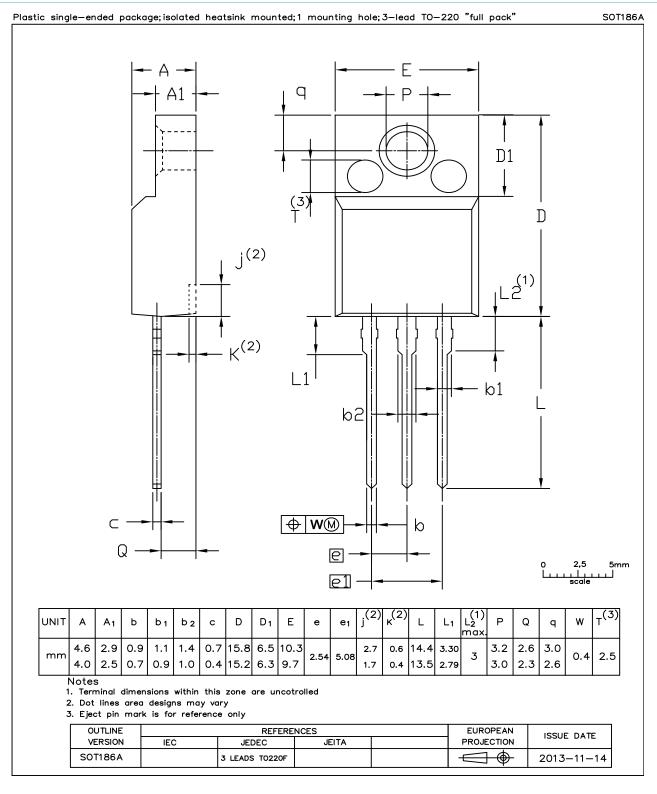


Fig. 12. Package outline TO-220F (SOT186A)

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11. Legal information

Data sheet status

Document status [1][2]	Product status [<u>3]</u>	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

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- [2] The term 'short data sheet' is explained in section "Definitions".
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